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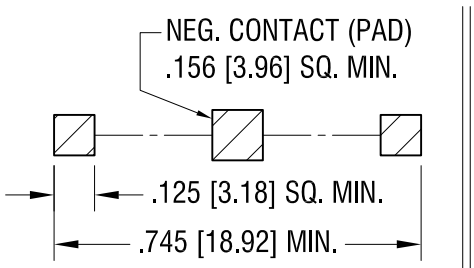
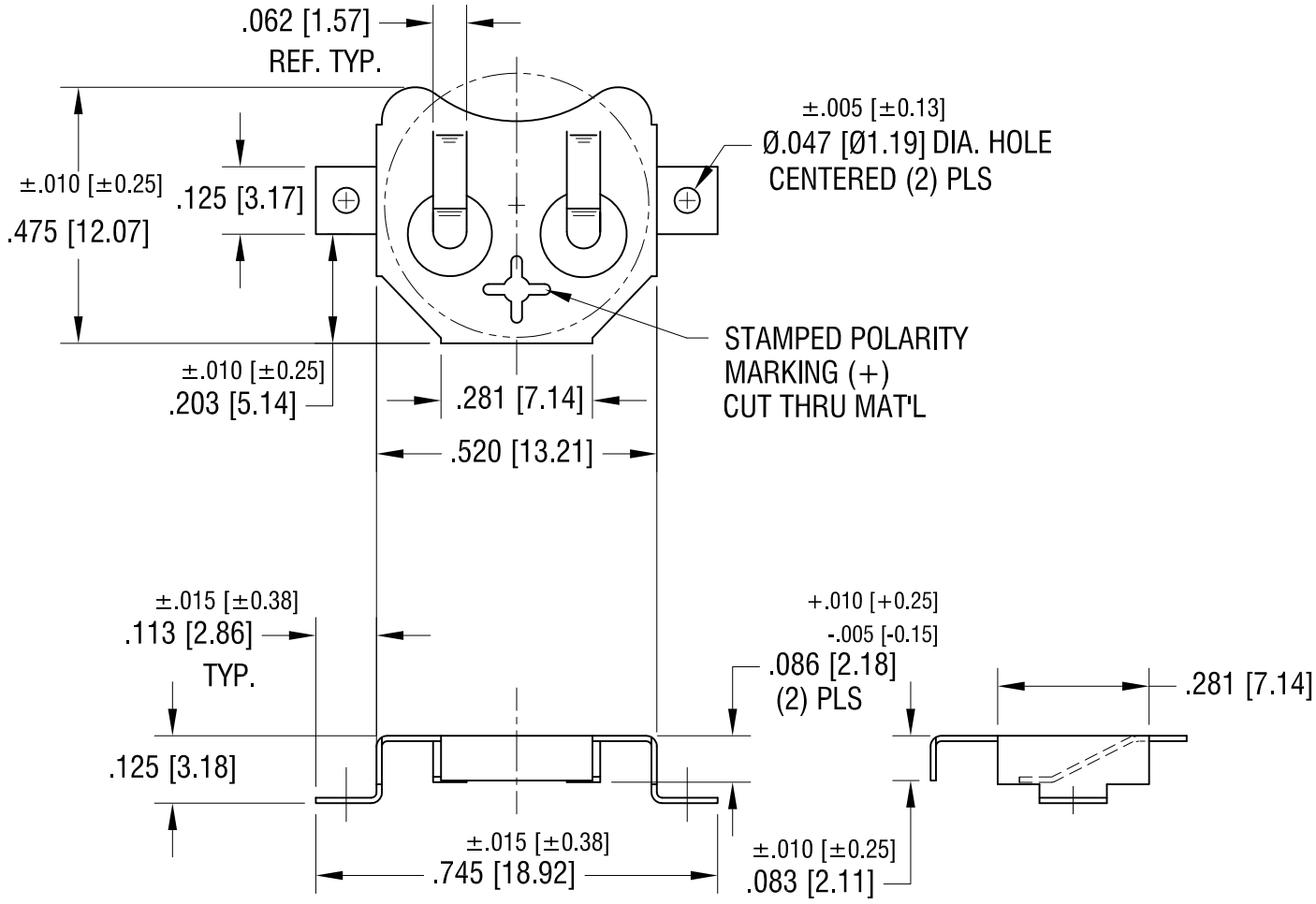


MOUNTING PAD LAYOUT

ACTUAL SIZE



DATE	DESCRIPTION	REV.
12.16.16	CHANGE AS PER ECN 16–104	M
5.07.15	CHANGE AS PER ECN 15–049	L
6.20.08	CHANGE AS PER ECN 08–111	K
9.22.06	CHANGE AS PER ECN 06–053	J

KEYSTONE ELECTRONICS CORP.

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PART NAME	12mm SM COIN CELL CLIP		
MATERIAL	.010 [0.25] TH'K PHOSPHOR BRONZE		
FINISH	TIN NICKEL PLATE	DRN BY BOONE	DATE 10.14.94
		APP'D LN	SCALE 3X
TOLERANCES INCH [MM] DECIMAL ± .010 [± 0.25] ANGULAR ± 1° UNLESS OTHERWISE SPECIFIED	CODE C	DWG NO. 3000	